# life.augmented

# STFU26N60M2

# N-channel 600 V, 0.14 Ω typ., 20 A MDmesh<sup>™</sup> M2 Power MOSFET in TO-220FP ultra narrow leads package

Datasheet - production data

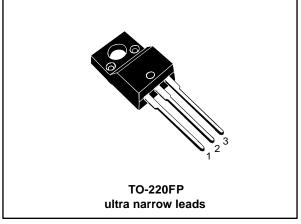
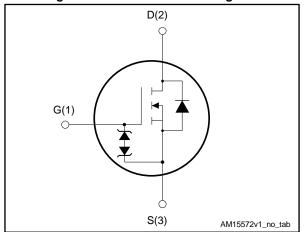


Figure 1: Internal schematic diagram



## **Features**

Order code	V <sub>DS</sub> @ T <sub>Jmax</sub>	R <sub>DS(on)</sub> max.	ID	Ρτοτ
STFU26N60M2	650 V	0.165 Ω	20 A	30 W

- Extremely low gate charge
- Excellent output capacitance (Coss) profile
- 100% avalanche tested
- Zener-protected

## **Applications**

- Switching applications
- LCC converters, resonant converters

## Description

This device is an N-channel Power MOSFET developed using MDmesh<sup>™</sup> M2 technology. Thanks to its strip layout and an improved vertical structure, the device exhibits low on-resistance and optimized switching characteristics, rendering it suitable for the most demanding high efficiency converters.

#### Table 1: Device summary

Order code Marking		Package	Packing	
STFU26N60M2	26N60M2	TO-220FP ultra narrow leads	Tube	

DocID030891 Rev 1

This is information on a product in full production.

### Contents

## Contents

1	Electric	al ratings	3
2	Electric	al characteristics	4
	2.1	Electrical characteristics (curves)	6
3	Test cir	cuits	8
4	Packag	e information	9
	4.1	TO-220FP ultra narrow leads package information	9
5	Revisio	n history	11



# 1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit
Vgs	Gate-source voltage	±25	V
ID <sup>(1)</sup>	Drain current (continuous) at T <sub>case</sub> = 25 °C	20	٨
ID( '	Drain current (continuous) at T <sub>case</sub> = 100 °C	13	A
I <sub>DM</sub> <sup>(2)</sup>	Drain current (pulsed)	80	А
P <sub>TOT</sub>	Total dissipation at $T_{case} = 25 \text{ °C}$	30	W
dv/dt <sup>(3)</sup>	Peak diode recovery voltage slope	15	V/ns
dv/dt <sup>(4)</sup>	MOSFET dv/dt ruggedness	50	v/ns
V <sub>ISO</sub>	Insulation withstand voltage (RMS) from all three leads to external heat sink (t = 1 s; $T_c = 25$ °C)	2.5	kV
T <sub>stg</sub>	Storage temperature range	55 to 150	°C
Tj	Operating junction temperature range	-55 to 150	C

#### Notes:

<sup>(1)</sup> Limited by maximum junction temperature.

 $^{\left( 2\right) }$  Pulse width is limited by safe operating area.

 $^{(3)}$  IsD  $\leq$  20 A, di/dt=400 A/µs; VDS(peak) < V(BR)DSS, VDD = 80% V(BR)DSS.

<sup>(4)</sup>  $V_{DS} \le 480 \text{ V}.$ 

#### Table 3: Thermal data

Symbol	Parameter	Value	Unit		
R <sub>thj-case</sub>	Thermal resistance junction-case	4.2	°C / M		
R <sub>thj-amb</sub>	Thermal resistance junction-ambient	62.5	°C/W		

#### **Table 4: Avalanche characteristics**

Symbol	Parameter	Value	Unit
lar <sup>(1)</sup>	Avalanche current, repetitive or not repetitive	3.8	А
E <sub>AR</sub> <sup>(2)</sup>	Single pulse avalanche energy	250	mJ

#### Notes:

 $^{\left( 1\right) }$  Pulse width limited by  $T_{jmax}.$ 

 $^{(2)}$  starting  $T_{j}$  = 25 °C,  $I_{D}$  =  $I_{AR},\,V_{DD}$  = 50 V.



# 2 Electrical characteristics

(T<sub>case</sub> = 25 °C unless otherwise specified)

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V <sub>(BR)DSS</sub>	Drain-source breakdown voltage	$V_{GS} = 0 V$ , $I_D = 1 mA$	600			V
Zara gata valtaga drain		$V_{GS} = 0 V, V_{DS} = 600 V$			1	
I <sub>DSS</sub> Zero gate voltage drain current	$V_{GS} = 0 V, V_{DS} = 600 V,$ $T_{case} = 125 \ ^{\circ}C^{(1)}$			100	μA	
Igss	Gate-body leakage current	$V_{DS} = 0 V$ , $V_{GS} = \pm 25 V$			±10	μA
V <sub>GS(th)</sub>	Gate threshold voltage	$V_{DS} = V_{GS}$ , $I_D = 250 \ \mu A$	2	3	4	V
R <sub>DS(on)</sub>	Static drain-source on- resistance	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 10 \text{ A}$		0.14	0.165	Ω

#### Notes:

<sup>(1)</sup>Defined by design, not subject to production test.

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Ciss	Input capacitance		-	1360	-	
Coss	Output capacitance	$V_{DS} = 100 V, f = 1 MHz,$	-	88	-	pF
C <sub>rss</sub>	Reverse transfer capacitance	$V_{GS} = 0 V$	-	2	-	рі
Coss eq. <sup>(1)</sup>	Equivalent output capacitance	$V_{\text{DS}}$ = 0 to 480 V, $V_{\text{GS}}$ = 0 V	-	124	-	pF
Rg	Intrinsic gate resistance	f = 1 MHz, I <sub>D</sub> = 0 A	-	4	-	Ω
Qg	Total gate charge	$V_{DD} = 480 V, I_D = 20 A,$	-	34	-	
Qgs	Gate-source charge	$V_{GS} = 0$ to 10 V (see Figure 15: "Test circuit for gate charge	-	5.6	-	nC
Q <sub>gd</sub>	Gate-drain charge	behavior")	-	16.3	-	

#### Table 6: Dynamic

#### Notes:

 $^{(1)}$  Coss eq. is defined as a constant equivalent capacitance giving the same charging time as Coss when VDS increases from 0 to 80% VDSS.

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t <sub>d(on)</sub>	Turn-on delay time	V <sub>DD</sub> = 300 V, I <sub>D</sub> = 10 A	-	20.2	-	
tr	Rise time	$R_G = 4.7 \Omega$ , $V_{GS} = 10 V$ (see	-	8	-	
t <sub>d(off)</sub>	Turn-off delay time	Figure 14: "Test circuit for	-	66	-	ns
tſ	Fall time	resistive load switching times")	-	10	-	

Table	7:	Swite	china	times
IUNIC		00000	SIIIIG	



#### Electrical characteristics

Table 8: Source-drain diode							
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit	
Isd	Source-drain current		-		20	А	
I <sub>SDM</sub> <sup>(1)</sup>	Source-drain current (pulsed)		-		80	А	
Vsd <sup>(2)</sup>	Forward on voltage	$V_{GS} = 0 V$ , $I_{SD} = 20 A$	-		1.6	V	
trr	Reverse recovery time	I <sub>SD</sub> = 20 A, di/dt = 100 A/µs,	-	360		ns	
Qrr	Reverse recovery charge	V <sub>DD</sub> = 60 V (see Figure 16: "Test circuit for inductive load	-	5		μC	
I <sub>RRM</sub>	Reverse recovery current	switching and diode recovery times")	-	27		А	
trr	Reverse recovery time	I <sub>SD</sub> = 20 A, di/dt = 100 A/µs,	-	556		ns	
Qrr	Reverse recovery charge	$V_{DD} = 60 \text{ V}, \text{ T}_{i} = 150 \text{ °C}$ (see Figure 16: "Test circuit for	-	8		μC	
Irrm	Reverse recovery current	inductive load switching and diode recovery times")	-	29		А	

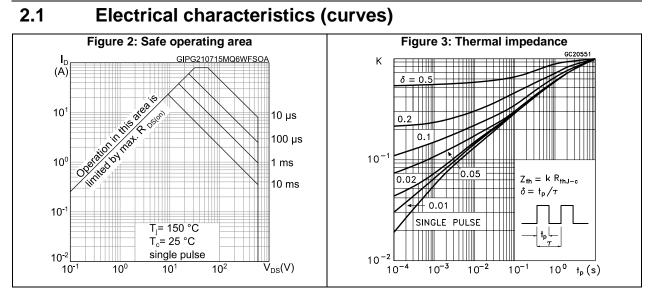
#### Notes:

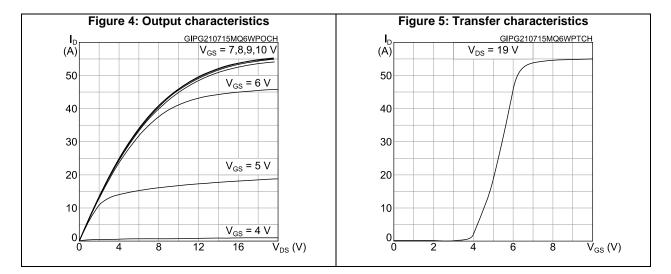
 $^{\left( 1\right) }$  Pulse width is limited by safe operating area.

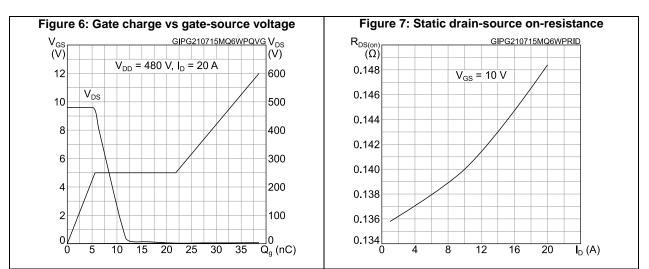
 $^{(2)}$  Pulse test: pulse duration = 300  $\mu s,$  duty cycle 1.5%.











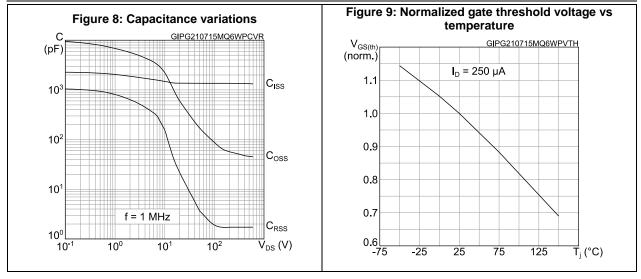
DocID030891 Rev 1

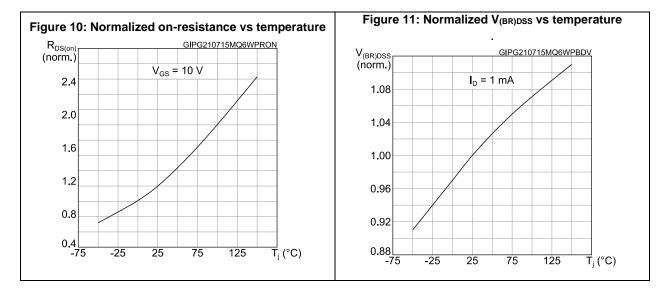


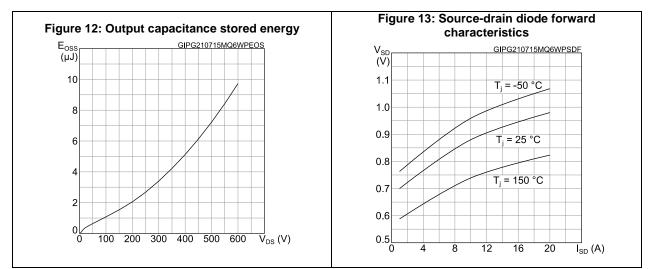
#### STFU26N60M2

57

#### **Electrical characteristics**

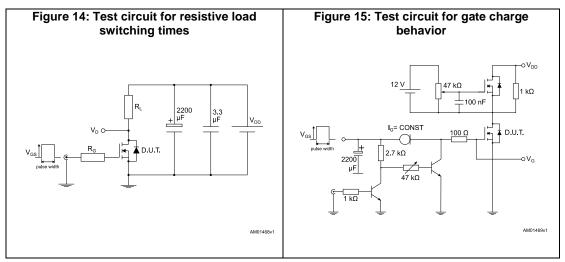


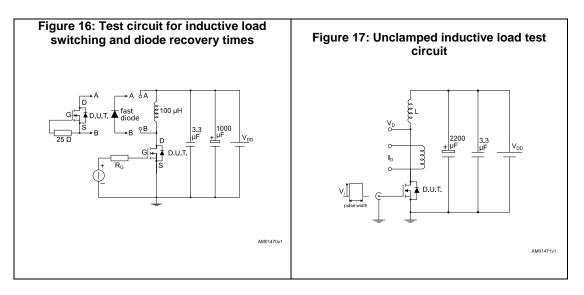


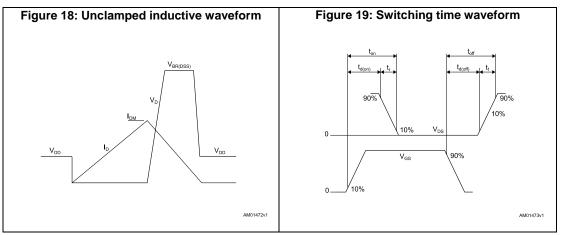


DocID030891 Rev 1

## 3 Test circuits







DocID030891 Rev 1



## 4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK<sup>®</sup> packages, depending on their level of environmental compliance. ECOPACK<sup>®</sup> specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK<sup>®</sup> is an ST trademark.

## 4.1 TO-220FP ultra narrow leads package information

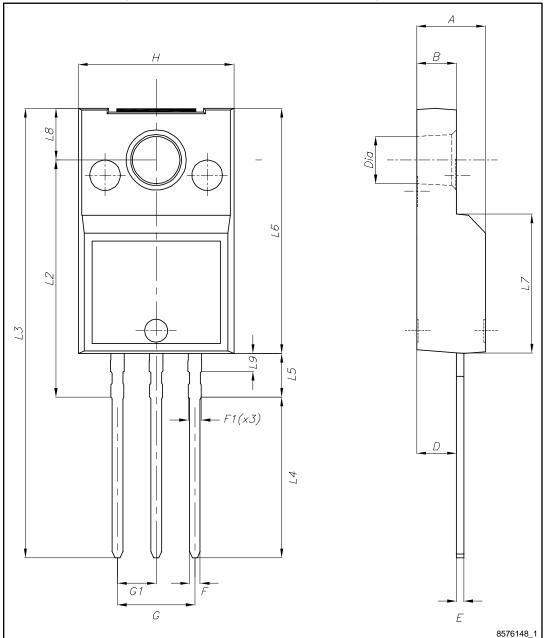


Figure 20: TO-220FP ultra narrow leads package outline



#### Package information

#### STFU26N60M2

ormation STFU26N60M2						
Та	ble 9: TO-220FP ultra nar	row leads mechanical of	data			
Dim		mm				
Dim.	Min.	Тур.	Max.			
A	4.40		4.60			
В	2.50		2.70			
D	2.50		2.75			
E	0.45		0.60			
F	0.65		0.75			
F1	-		0.90			
G	4.95		5.20			
G1	2.40	2.54	2.70			
Н	10.00		10.40			
L2	15.10		15.90			
L3	28.50		30.50			
L4	10.20		11.00			
L5	2.50		3.10			
L6	15.60		16.40			
L7	9.00		9.30			
L8	3.20		3.60			
L9	-		1.30			
Dia.	3.00		3.20			



## 5 Revision history

Table 10: Document revision history

Date	Revision	Changes
27-Jul-2017	1	First release.



#### IMPORTANT NOTICE – PLEASE READ CAREFULLY

STMicroelectronics NV and its subsidiaries ("ST") reserve the right to make changes, corrections, enhancements, modifications, and improvements to ST products and/or to this document at any time without notice. Purchasers should obtain the latest relevant information on ST products before placing orders. ST products are sold pursuant to ST's terms and conditions of sale in place at the time of order acknowledgement.

Purchasers are solely responsible for the choice, selection, and use of ST products and ST assumes no liability for application assistance or the design of Purchasers' products.

No license, express or implied, to any intellectual property right is granted by ST herein.

Resale of ST products with provisions different from the information set forth herein shall void any warranty granted by ST for such product.

ST and the ST logo are trademarks of ST. All other product or service names are the property of their respective owners.

Information in this document supersedes and replaces information previously supplied in any prior versions of this document.

© 2017 STMicroelectronics - All rights reserved



# **Mouser Electronics**

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

STMicroelectronics: STFU26N60M2